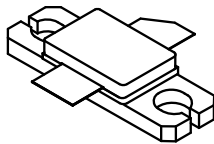
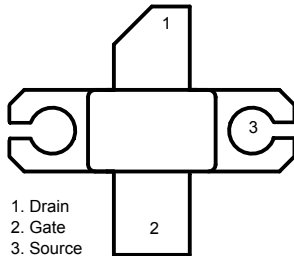


RF Power LDMOS transistor HF up to 1.5 GHz



M243
Epoxy sealed



GADG310120180952IG

Features

- Excellent thermal stability
- Common source configuration
- P_{OUT} (@28 V) = 45 W with 18.5 dB gain @945 MHz
- BeO free package
- In compliance with European Directive 2002/95/EC

Description

The ST9045C is a common source N-channel enhancement-mode lateral field-effect RF power transistor designed for broadband commercial and industrial applications at frequencies up to 1.5 GHz. The ST9045C is designed for high gain and broadband performance operating in common source mode at 28 V. It is ideal for base station applications requiring high linearity.

Product status link

[ST9045C](#)

Product summary

| | |
|-------------------|---------|
| Order code | ST9045C |
| Package | M243 |
| Branding | ST9045C |

1 Maximum ratings

($T_{CASE} = 25\text{ °C}$)

Table 1. Absolute maximum ratings

| Symbol | Parameter | Value | Unit |
|---------------|---|-------------|------|
| $V_{(BR)DSS}$ | Drain-source voltage | 90 | V |
| V_{GS} | Gate-source voltage | -10 +13 | V |
| I_D | Drain current | 9 | A |
| P_{DISS} | Power dissipation (@ $T_C = 70\text{ °C}$) | 130 | W |
| T_J | Maximum operating junction temperature | 200 | °C |
| T_{STG} | Storage temperature | -65 to +150 | °C |

Table 2. Thermal data

| Symbol | Parameter | Value | Unit |
|------------|----------------------------------|-------|------|
| R_{thJC} | Junction-case thermal resistance | 1.0 | °C/W |

2 Electrical characteristics

($T_{CASE} = 25\text{ °C}$)

Table 3. Static

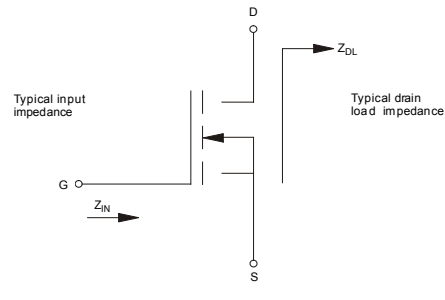
| Symbol | Test conditions | Min. | Typ. | Max. | Unit |
|---------------|---|------|------|------|---------------|
| $V_{(BR)DSS}$ | $V_{GS} = 0\text{ V}, I_{DS} = 10\text{ mA}$ | 90 | 100 | | V |
| I_{DSS} | $V_{GS} = 0\text{ V}, V_{DS} = 28\text{ V}$ | | | 1 | μA |
| I_{GSS} | $V_{GS} = 12\text{ V}, V_{DS} = 0\text{ V}$ | | | 1 | μA |
| $V_{GS(Q)}$ | $V_{DS} = 28\text{ V}, I_{DS} = 300\text{ mA}$ | 2 | 3 | 5 | V |
| $V_{DS(ON)}$ | $V_{GS} = 10\text{ V}, I_{DS} = 3\text{ A}$ | | 1 | 1.3 | V |
| G_{FS} | $V_{DS} = 10\text{ V}, I_{DS} = 3\text{ A}$ | | 3.3 | | S |
| C_{ISS} | $V_{GS} = 0\text{ V}, V_{DS} = 28\text{ V}, f = 1\text{ MHz}$ | | 54 | | pF |
| C_{OSS} | $V_{GS} = 0\text{ V}, V_{DS} = 28\text{ V}, f = 1\text{ MHz}$ | | 18 | | pF |
| C_{RSS} | $V_{GS} = 0\text{ V}, V_{DS} = 28\text{ V}, f = 1\text{ MHz}$ | | 1.2 | | pF |

Table 4. Dynamic (RF spec @ 945 MHz)

| Symbol | Test conditions | Min. | Typ. | Max. | Unit |
|---------------|---|------|------|------|------|
| P_{OUT} | $V_{DD} = 28\text{ V}, I_{DQ} = 300\text{ mA}, P_{IN} = 1\text{ W}$ | | 63 | - | W |
| Gain | $V_{DD} = 28\text{ V}, I_{DQ} = 300\text{ mA}, P_{IN} = 1\text{ W}$ | | 18.5 | - | dB |
| Efficiency | $V_{DD} = 28\text{ V}, I_{DQ} = 300\text{ mA}, P_{IN} = 1\text{ W}$ | | 70 | - | % |
| Load mismatch | $V_{DD} = 28\text{ V}, I_{DQ} = 300\text{ mA}, P_{OUT} = 45\text{ W}$ All phase angles | 20:1 | | - | VSWR |

3 Impedance data

Figure 1. Impedance data



AM09249V1

Table 5. Impedance data

| Frequency (MHz) | $Z_{IN}\Omega$ | $Z_{DL}\Omega$ |
|-----------------|-----------------|----------------|
| 945 | $0.76 + j 0.11$ | $5.2 - j 0.87$ |

4 Typical performance

Figure 2. Power gain and efficiency vs output power and I_{dq} ($V_{DD} = 28\text{ V}$, $f_o = 945\text{ MHz}$)

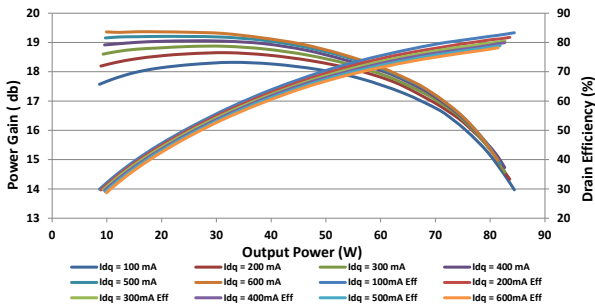


Figure 3. Power gain and efficiency vs output power and V_{DD} ($I_{dq} = 300\text{ mA}$, $f_o = 945\text{ MHz}$ tuned at $V_{DD} = 28\text{ V}$)

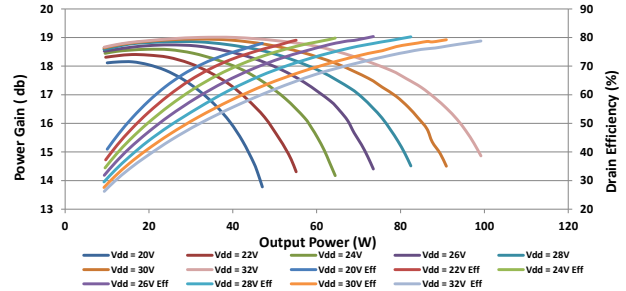


Figure 4. Output power and efficiency vs V_{DD} and input power ($I_{dq} = 300\text{ mA}$, $f_o = 945\text{ MHz}$ tuned at $V_{DD} = 28\text{ V}$)

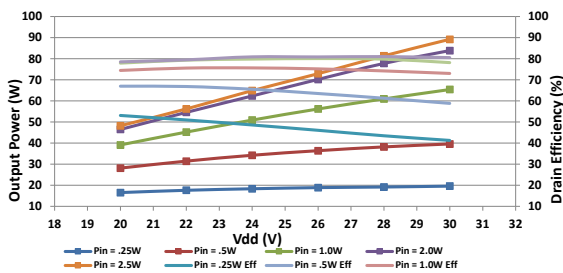


Figure 5. Output power and drain current vs V_{DD} and input power ($I_{dq} = 300\text{ mA}$, $f_o = 945\text{ MHz}$ tuned at $V_{DD} = 28\text{ V}$)

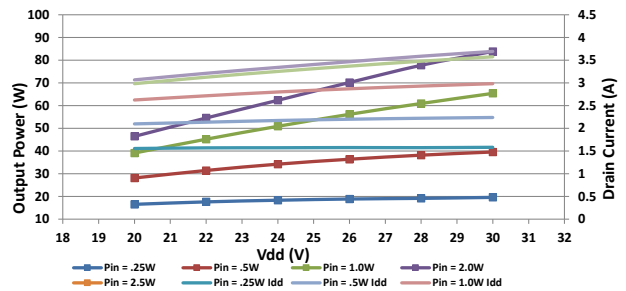


Figure 6. Output power and drain current vs V_{GS} and input power ($V_{DD} = 28\text{ V}$, $f_o = 945\text{ MHz}$)

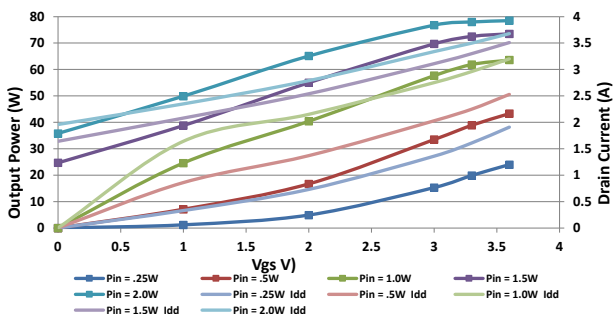


Figure 7. Output power vs V_{GS} and input power ($V_{DD} = 28\text{ V}$, $f_o = 945\text{ MHz}$)

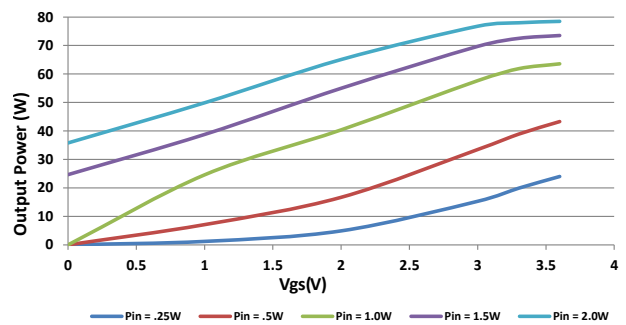


Figure 8. Drain current vs V_{GS} and input power ($V_{DD} = 28$ V, $f_o = 945$ MHz)

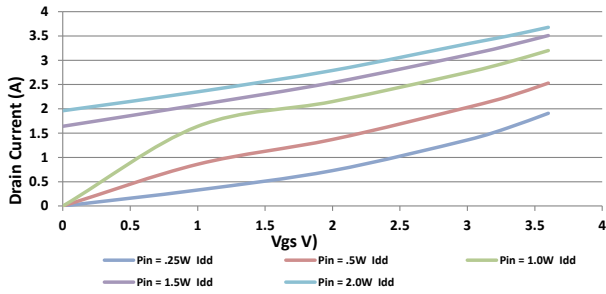
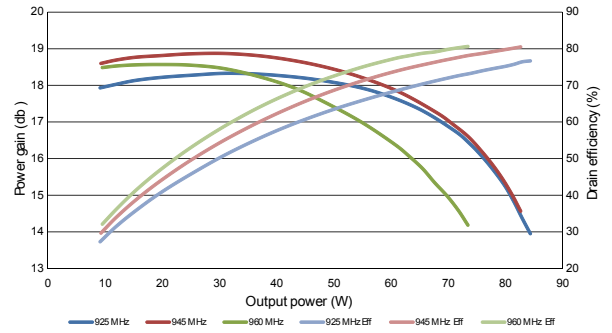
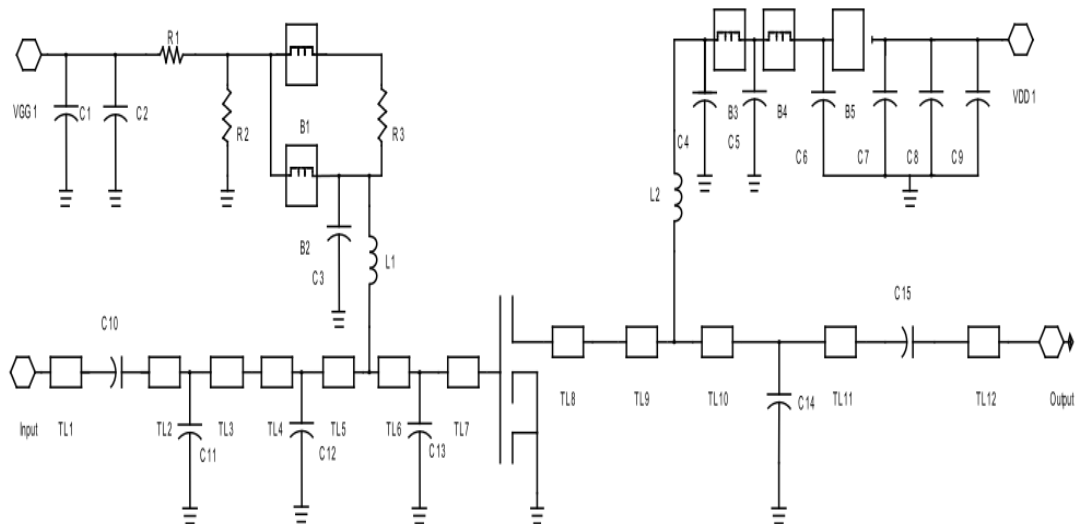


Figure 9. Power gain and efficiency vs frequency ($V_{DD} = 28$ V, $I_{dq} = 300$ mA tuned at 945 MHz)

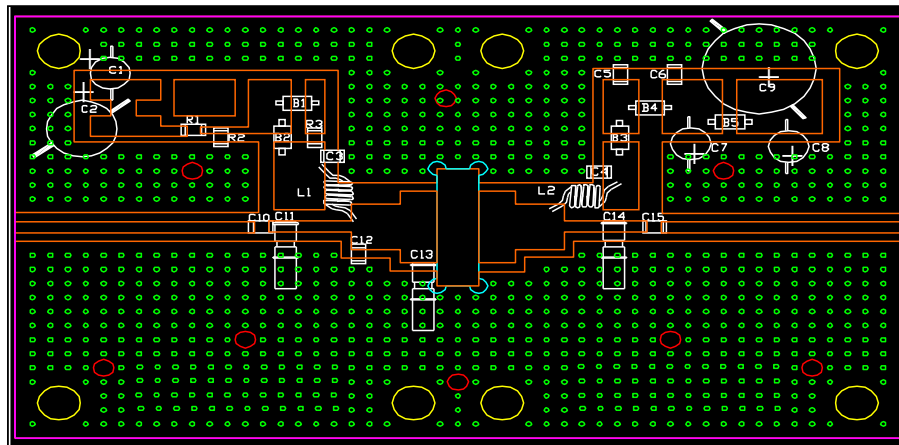


5 Test circuit

Figure 10. Test circuit

Table 6. ST9045C components list

| Item | Quantity | Part number | Vendor | Description |
|--------------------|----------|-----------------|---------------------|---|
| R1, R2 | 2 | CR1206-8W-112JB | VENKEL | 1.1 k Ω 1/8 W surface mount chip resistor |
| R3 | 1 | CR1206-8W-100JB | VENKEL | 10 Ω 1/8 W surface mount chip resistor |
| Coil | 2 | | BELDEN | Inductor 5 turn air wound #20 AWG ID = 0.130 inches (3.3 mm) nylon coated |
| B1, B2, B3, B4, B5 | 5 | 2743021447 | Fair-Rite Products | Surface mount EMI shield bead |
| C1, C7, C8 | 3 | T491D106K035AT | KEMET | 10 μ F 35 V tantalum capacitors |
| C2 | 1 | | | 100 μ F 63 V electrolytic capacitor |
| C3, C4, C10, C15 | 4 | ATC100B470XXXX | ATC | 47 pF chip capacitor |
| C5, C6 | 2 | ATC200B393MW | ATC | 39000 pF chip capacitor |
| C9 | 1 | | | 330 μ F 50 V electrolytic capacitor |
| C11, C13, C14 | 3 | 27291PC | Johanson Technology | 0.8 to 8 pF giga-trim variable capacitor |
| C12 | 1 | ATC100B4R7XXXX | ATC | 4.7 pF chip capacitor |
| TL1 | | | | L = 1.350 inches [34.29 mm] W = 0.082 inches [02.08 mm] |
| TL2 | | | | L = 0.144 inches [3.65 mm] W = 0.082 inches [02.08 mm] |
| TL3 | | | | L = 0.311 inches [7.91 mm] W = 0.082 inches [02.08 mm] |
| TL4 | | | | L = 00.82 inches [2.09 mm] W = 0.323 inches [08.21 mm] |

| Item | Quantity | Part number | Vendor | Description |
|-----------|----------|-------------|--------|--|
| TL5 | | | | L = 0.194 inches [4.94 mm] W = 0.323 inches [08.21 mm] |
| TL6 | | | | L = 0.059 inches [1.49 mm] W = 0.506 inches [12.85 mm] |
| TL7 | | | | L = 0.144 inches [3.65 mm] W = 0.506 inches [12.85 mm] |
| TL8 | | | | L = 0.208 inches [5.28 mm] W = 0.506 inches [12.85 mm] |
| TL9 | | | | L = 0.275 inches [6.98 mm] W = 0.323 inches [08.21 mm] |
| TL10 | | | | L = 0.210 inches [5.33 mm] W = 0.082 inches [02.08 mm] |
| TL11 | | | | L = 0.260 inches [6.60 mm] W = 0.082 inches [02.08 mm] |
| TL12 | | | | L = 1.350 inches [34.29 mm] W = 0.082 inches [02.08 mm] |
| Board 3X5 | 1 | | ROGERS | Er = 2.55, t = 0.0026 inches, h = 0.030 inches |

Figure 11. Circuit layout


6 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

6.1 M243 (.230 x .360 2L N/HERM W/FLG) package information

Figure 12. M243 (.230 x .360 2L N/HERM W/FLG) package outline

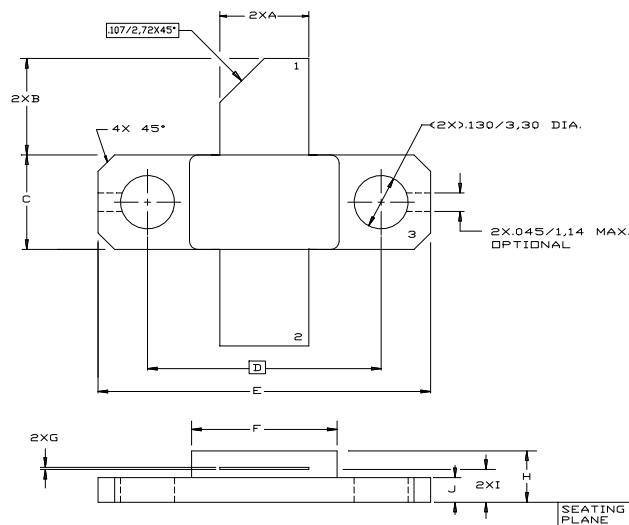


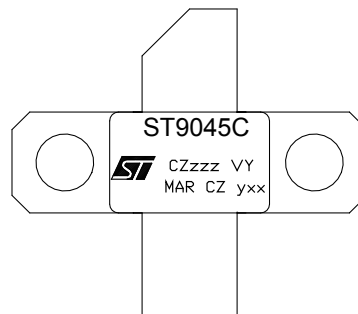
Table 7. M243 (.230 x .360 2L N/HERM W/FLG) package mechanical data

| Dim. | mm | | |
|------|-------|-------|-------|
| | Min. | Typ. | Max. |
| A | 5.21 | | 5.72 |
| B | 5.46 | | 6.48 |
| C | 5.59 | | 6.1 |
| D | | 14.27 | |
| E | 20.07 | | 20.57 |
| F | 8.89 | | 9.4 |
| G | 0.1 | | 0.15 |
| H | 3.18 | | 4.45 |
| I | 1.83 | | 2.24 |
| J | 1.27 | | 1.78 |

7 Marking, packing and shipping specifications

Table 8. Packing and shipping specifications

| Order code | Packing | Pieces per tray | Dry pack humidity | Lot code |
|------------|--------------|-----------------|-------------------|----------------|
| ST9045C | Plastic tray | 25 | < 10% | Two codes max. |

Figure 13. Marking layout

Table 9. Marking specifications

| Symbol | Description |
|--------|--------------------------------|
| CZ | Assembly plant |
| zzz | Last 3 digits of diffusion lot |
| VY | Diffusion plant |
| MAR | Country of origin |
| CZ | Test and finishing plant |
| y | Assembly year |
| xx | Assembly week |

Revision history

Table 10. Document revision history

| Date | Revision | Changes |
|-------------|----------|---|
| 03-Mar-2016 | 1 | Initial release. |
| 24-Jan-2018 | 2 | Updated title and description on cover page. Updated <i>Section 2: "Electrical characteristics"</i> . Updated <i>Section 4: "Typical performance"</i> . Minor text changes |
| 16-Mar-2018 | 3 | Updated package silhouette and pin connection in cover page. |

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